Embedded Systems and High Performance Computing (EPiC) Lab





Prof. Sudeep Pasricha (Director) Monfort and Rockwell-Anderson Professor Dept. of Electrical and Computer Engineering | Dept. of Computer Science Colorado State University, Fort Collins, CO – 80523 email: sudeep@colostate.edu



Mission: Algorithms and architectures for energy-efficient, fault-tolerant, and secure design of embedded systems (cyber-physical systems), mobile computing (smartphones, wearables, internet-of-things), and high performance computing (datacenters, supercomputers)

CAD Tools for Multicore Chip Design

- Nearly all modern innovations depend on continued advances in multicore system-on-chip computing performance
 - Major impact on innovation across application domains: automotive, defense, medical, multimedia, telecommunications, aerospace, mobile/cloud computing



Network-on-Chip (NoC) Architectures

Design of on-chip communication fabric is a very critical factor influencing multicore chip performance, power, and reliability

- **NoCs have replaced on-chip buses, but face challenges**
- High packet transfer latency with increasing core counts
- High susceptibility to transient (soft) and permanent (aging/hard) faults
- Need to balance multiple goals while satisfying design constraints
- Fault-tolerant NoC protocols and adaptation
 - Reliable NoC packet routing algorithms OE+IOE: hybrid multiple turn-model routing algorithm for 2D NoCs • 4NP-First: hybrid turn-model routing algorithm for 3D NoCs Fault vulnerability aware NoC optimizations Proposed network vulnerability factor (NVF) metric to characterize vulnerability of network interfaces and routers to faults

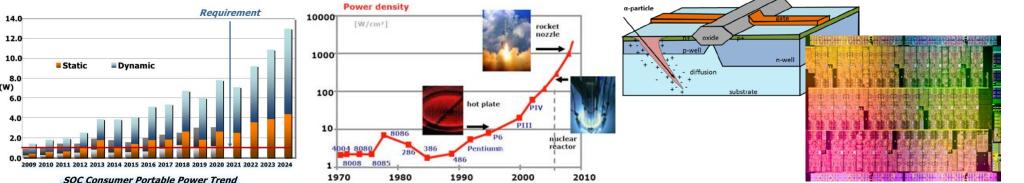


Memory Architectures

- Improvement in memory density, bandwidth, and form factor are critical for next generation multicore computing chips
 - To support increasing data demands from rising chip core counts, growing graphics capabilities, the Big Data revolution, and higher network/Ethernet speeds
 - Challenges:
 - How to scale memory component density?
 - How to increase bandwidth and reduce latency?
 - How to best manage power dissipation/energy?
- New 3D DRAM architectures

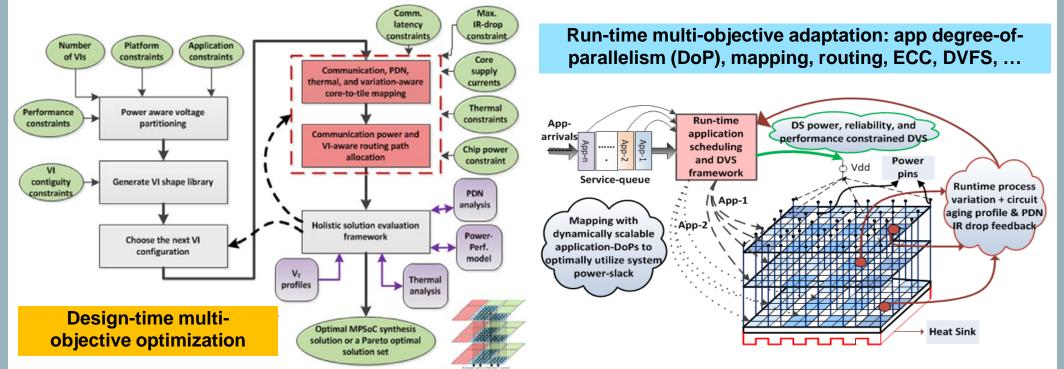


- But multicore system-on-chip design in advanced semiconductor fabrication technologies today faces several challenges
- High power/energy dissipation that increases costs and limits achievable performance
- Process, voltage, and thermal variations that cause uncertainty and high time-to-market
- Increasing susceptibility to transient and permanent faults that reduces design reliability

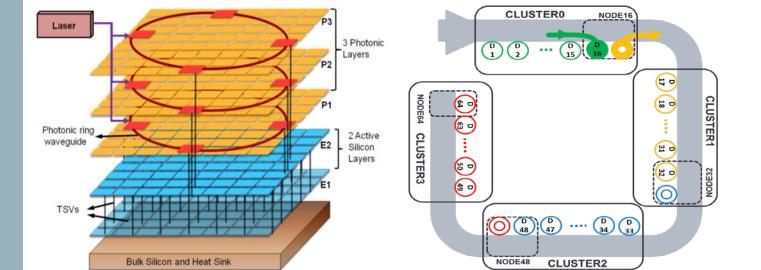


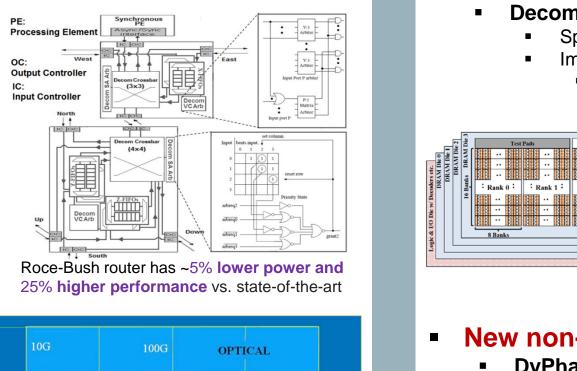
Need new computer-aided design (CAD) tools to perform multi-objective chip design exploration and optimization

- Novel CAD tools for emerging 2D/3D multicore chip design
 - Design-time algorithms for core/memory/network selection and configuration
 - Run-time algorithms to map computation, communication, and data on the chip die
 - Co-optimize: performance, energy/power, soft/hard fault resilience, security, yield, cost, …



- NoC architecture optimization
 - Roce-Bush NoC router for 3D NoCs
 - Routing algorithm-aware decomposition of NoC router
 - Memory- and application-aware NoC prioritization
 - Heterogeneous NoC scheduling with anti-starvation support
- Photonic NoC architectures
 - Speed of light latency, low power, high throughput
 - Scale much better than traditional electrical wires!
 - Challenges:
 - Photonic crosstalk Process variations
 - Thermal variations
 - Topology design
 - Protocol design
 - Fabrication choices Off-chip interfacing
 - Solutions:
 - New 2D/3D photonic NoC architectures Free-space, mono-layer, multi-layer
 - New cross-layer (device, circuit, system) techniques To overcome crosstalk and variation uncertainty
 - New photonic arbitration, encoding, flow-control protocols
 - New off-chip CPU-memory photonic architectures





Silicon Photonic

 $T = T_2$

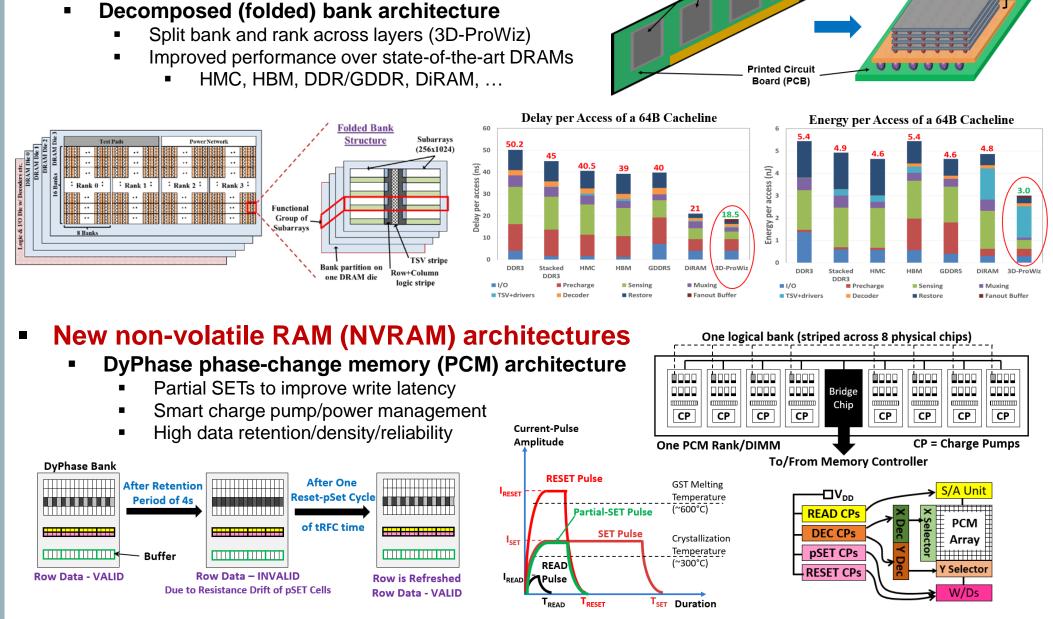
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 $\boldsymbol{\lambda}_3 \ \boldsymbol{\lambda}_2 \ \boldsymbol{\lambda}_1$

 $R_4 R_3 R_2 R_2$

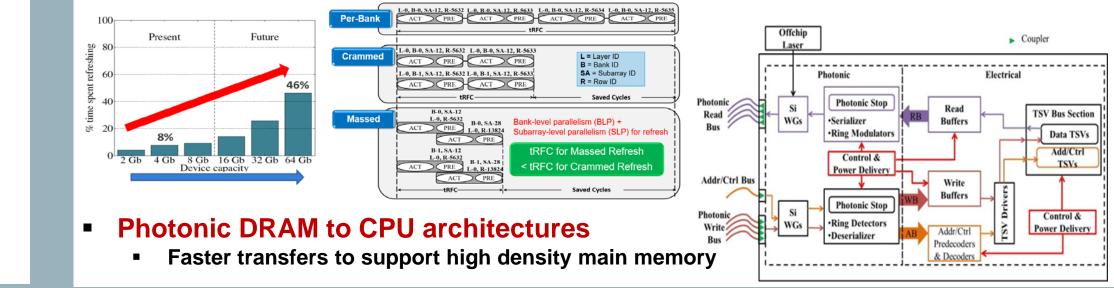
 $\boldsymbol{\lambda}_{n} \ \boldsymbol{\lambda}_{n-1} \boldsymbol{\lambda}_{n-2}$

 $R_n R_{n-1}$



DRAM and cache/scratchpad memory optimizations

- DRAM refresh overhead reduction (new massed/crammed refresh techniques)
- Scratchpad data placement (static and adaptive packing strategies)
- Hybrid SRAM/NVRAM cache architecture design; policy configuration



Automotive Embedded Systems

High Performance Computing

 $R_n R_{n-1}$

 $R_4 R_3 R_2 R_1$

- Many embedded systems use cloud computing
- Mobile Computing
- Schedule Thermal Sensors AMA AWDTN Thread Migratio

emperature

Red Shift in MR

Wavelength

ELECTRICAL

Vehicles are controlled by distributed, real-time embedded systems

- Hundreds of embedded controllers/devices and millions of lines of code
- Connected by multiple, diverse network protocols
- Challenge:
 - Meet real-time computation and communication requirements
 - Prevent security breaches (tampering, snooping, ...)
 - Support advanced driver-assistance systems (ADAS)

Jitter and security-aware automotive network design

- Dynamically adapt to unpredictable performance jitters (delays)
- Prevent security breaches with lightweight key management protocols
- Adapt to heterogeneous network types: CAN, FlexRay, TTEthernet, wireless,



















Advanced driver assistance system (ADAS) algorithms and prototyping

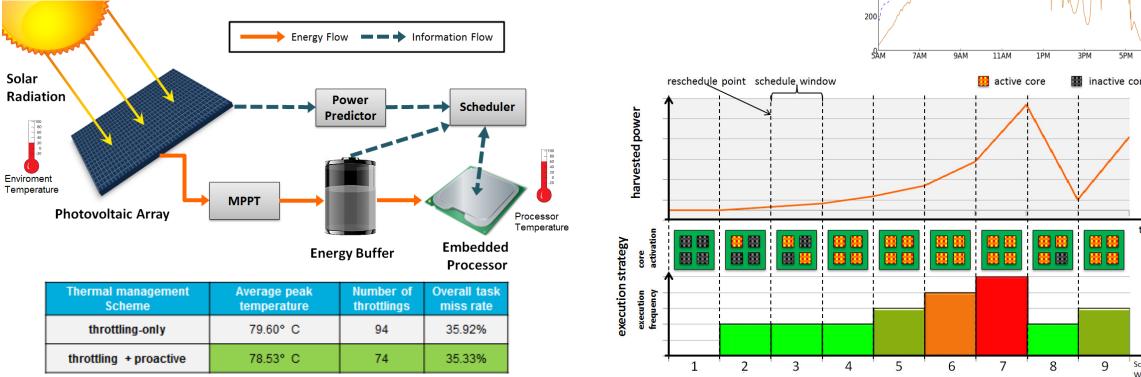
- Enable autonomous vehicles: design robust vehicle/pedestrian/traffic-light/sign/lane detection algorithms
- Implement vision algorithms on low-power ADAS boards, smartphones, tablets
- Utilize stereo vision cameras, and other data from: LIDAR, RADAR, vehicle-to-vehicle, vehicle-to-infrastructure

Energy Harvesting IoT Platforms

- Solar energy harvesting can power many IoT and embedded systems
 - How to schedule software applications on multicore platforms under variant and stringent energy harvesting conditions that often exist at runtime?
 - How to cope with thermal spikes and faults arising at runtime?

Run-time harvesting-aware scheduling framework

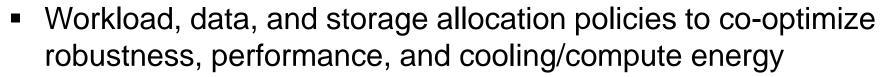
- Dynamically enables/disables cores, scales voltage/frequency to manage energy
- Proactively throttles cores to manage temperature
- Distributes and dynamically reassigns software to maximize core utilization



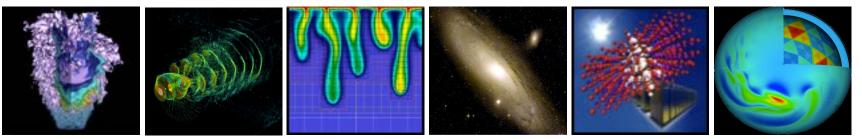
- Major challenge in designing datacenters that support cloud computing as well as supercomputers that solve large scientific problems: need for energy-efficient operation
 - Energy costs today ~ \$1M/year/petaflop Cannot sustain such costs at exascale!
- How can we reduce energy costs?

Energy Efficient and Stochastically Robust Resource Allocation

- Workload and system uncertainty modeling
 - Model uncertainty in execution time, network † transfers, data access, and GPU offloading
- Quantify task and machine heterogeneities in real world HPC systems
- Analysis of thermal and energy dynamics
 - Real time thermal analysis
 - Adapting thermal setpoints
 - Characterize cooling energy & costs
- **Smart resource allocation algorithms**

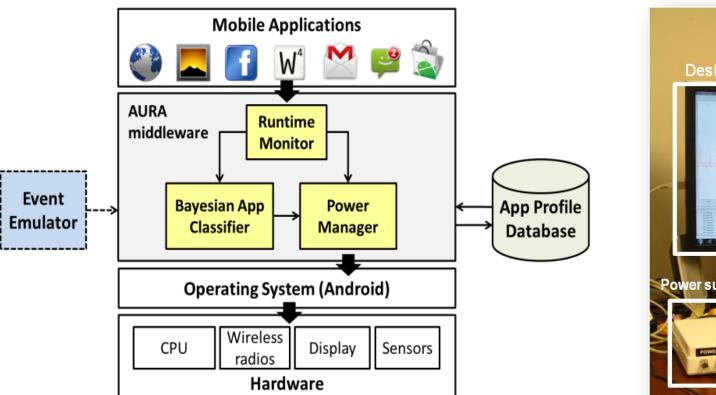


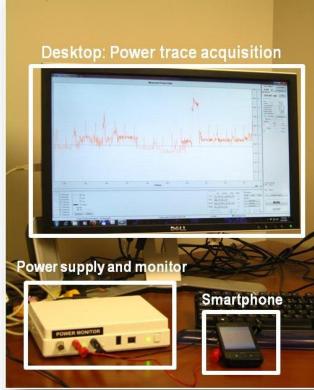
- Based on uncertainty models and thermal/energy analysis
- Validation on diverse scientific applications and real world teraand peta-scale systems at NCAR, DOE/ORNL, and CSU



- Another major challenge: ensuring fault-resilient operation Exascale HPC systems will experience a fault every few minutes!
- How to quickly and effectively recover from frequent faults?
- **Reliability exploration/management for extreme-scale HPC**
- Analysis of checkpointing, redundancy based techniques

- **Energy demands** and **capabilities** of "smart" mobile devices are increasing rapidly with growing mobile app complexity
 - But battery technology is lagging behind and is expected to continue to be a limiting factor for future growth of mobile devices such as smartphones
 - How to intelligently manage energy and improve battery lifetime for mobile devices?



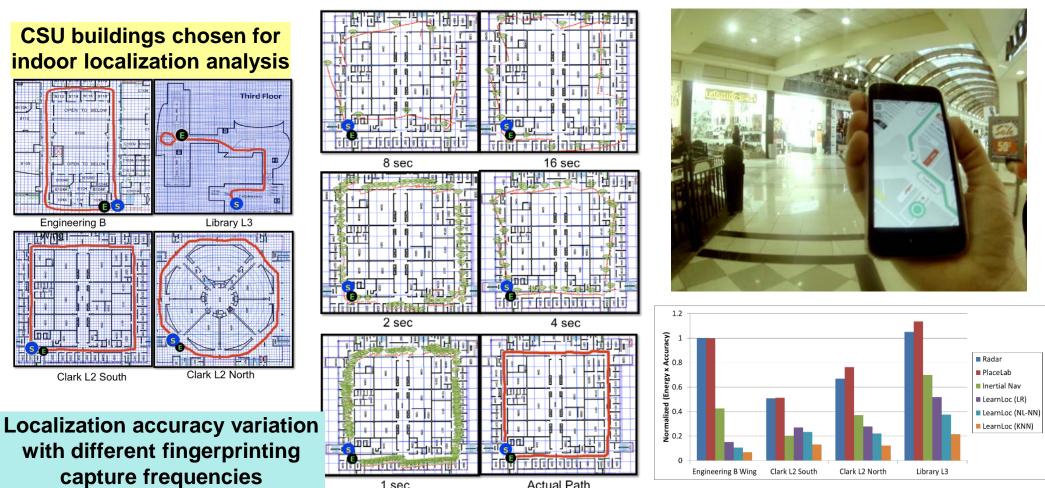


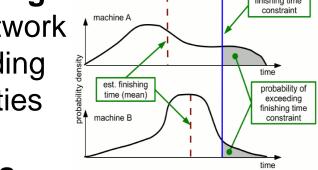
- AURA middleware for CPU/backlight energy optimization
 - Predicts idle periods (perceptual, cognitive, motor) during user-app interactions
 - Bayesian classification of mobile apps at runtime based on user-device interactions
 - Markov Decision Process (MDP) based algorithms to control:
 - dynamic voltage/freq. scaling (DVFS) for CPU energy saving during idle periods
 - backlight level (and energy) reduction based on theory of human change blindness
 - Power model based on real measurements of various Android OS-based smartphones
- Avg. energy savings of 29% vs. default Android scheme; 5x over prior work; no QoS impact

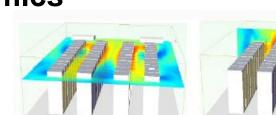
Context-aware cloud offloading, wireless data transfers, and outdoor location sensing

- Reduce energy for data transmission and outdoor location sensing on mobile devices
- Use software-based machine learning techniques to learn usage of data and location interfaces to determine optimal interface selection, ON/OFF schedule, configuration
 - Linear discriminant analysis, linear logistic regression, Non-linear logistic regression with neural networks, k-nearest neighbor, Support vector machines
- Use similar techniques to determine when it is beneficial to compute in cloud vs. device
- Up to **85%** energy savings vs. default Android scheme; **24%** savings over prior work

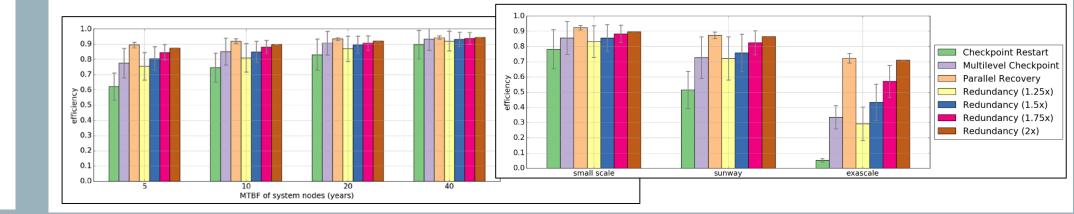
CSU buildings chosen for indoor localization analysis



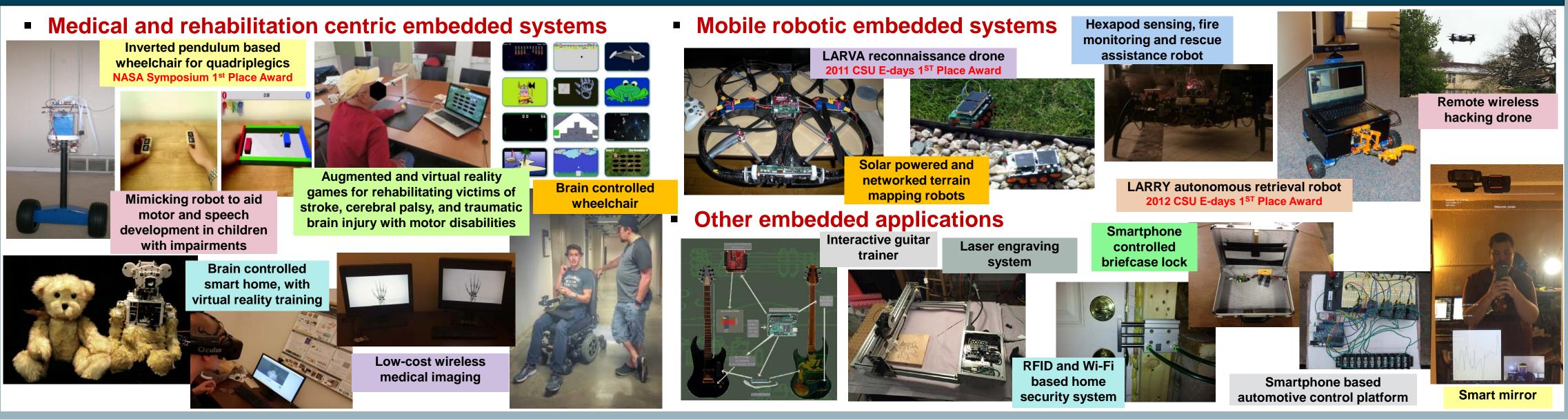








Embedded System Applications and Prototypes



Energy-efficient and accurate indoor location sensing

- Indoor location sensing is difficult due to lack of GPS signals in indoor environments
- Current techniques are energy-hungry, lack accuracy, and are very infrastructure dependent
- Can use Wifi/UWB/cellular fingerprinting and inertial sensors to predict location indoors
- Use machine learning techniques (LearnLoc) together with fingerprinting and inertial sensing (dead reckoning) to improve prediction accuracy and save energy
- Critical for search-and-rescue during emergency scenarios (e.g., cave-ins in mining)

Graduate Students

Current: Sai Chittamuru, Ishan Thakkar, Daniel Dauwe, Yaswanth Raparti, Vipin Kukkala, Saideep Tiku, Shoumik Maiti, Greg Kittilson, Ninad Hogade, Yahav Biran, Chris Langlois, Varun Kilenje, Swapnil Bhosale, Ayush Kumar, Jordan Tunnell, Zemin Tao, Rohit Kudre, Rohan Jhaveri

Alumni: Shirish Bahirat, Yong Zou, Yi Xiang, Nishit Kapadia, Mark Oxley, Brad Donohoo, Pramit Rajakrishna, Miguel Salas, Tejasi Pimpalkhute, Viney Ugave, Eric Jonardi, Yuhang Li, Srinivas Desai, Haneet Mahajan, Aditya Khune, Onkar Gulvani, Jiabao Jin, Manoj Kumar, Sai Kiran, Nanda Kumar, Taylo Santiago, Surya Vamsi Vemparala, Jingjie Zhu